



SY89854U

Precision Low Power 1:4 LVPECL Fanout Buffer/Translator with Internal Termination

General Description

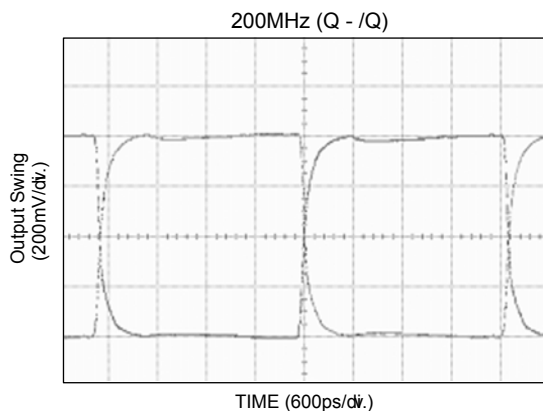
The SY89854U is a 2.5V/3.3V precision, high-speed, fully differential 1:4 LVPECL fanout buffer. Optimized to provide four identical output copies with less than 20ps of skew and less than 10ps_(pp) total jitter, the SY89854U can process clock signals as fast as 2GHz.

The differential input includes Micrel's unique, patent pending 3-pin input termination architecture that interfaces to any differential signal (AC or DC-coupled) as small as 100mV (200mV_{pp}) without any level shifting or termination resistor networks in the signal path. For AC-coupled input interface applications, an on-board output reference voltage (VREF-AC) is provided to bias the center-tap (VT) pin. The outputs are 800mV LVPECL, with fast rise/fall times guaranteed to be less than 180ps.

The SY89854U operates from a 2.5V ±5% supply or a 3.3V ±10% supply and is guaranteed over the full industrial temperature range of -40°C to +85°C. The SY89854U is part of Micrel's high-speed, Precision Edge[®] product line.

All support documentation can be found on Micrel's web site at: www.micrel.com.

Typical Applications



Precision Edge is a registered trademark of Micrel, Inc.
MicroLeadFrame and MLF are trademarks of Amkor Technology, Inc.



Precision Edge[®]

Features

- Precision 1:4, LVPECL fanout buffer
- Low power: 137mW (2.5V typ)
- Guaranteed AC performance over temperature and supply voltage:
 - DC- to > 2GHz Clock f_{MAX}
 - <340ps t_{pd}
 - <180ps t_r/t_f time
 - <20ps max. skew
- Ultra-low jitter design:
 - <1ps_(rms) random jitter
 - <10ps_(pp) deterministic jitter
 - <10ps_(pp) total jitter (clock)
- Unique patent pending input termination and VT pin accepts DC-coupled and AC-coupled inputs (CML, PECL, LVDS)
- Typical 800mV (100k) LVPECL output swing
- Power supply 2.5V ±5% or 3.3V ±10%
- Industrial temperature range -40°C to +85°C
- Available in ultra-small (3mm x 3mm) 16-pin MLF[®] package

Applications

- SONET and All GigE clock distribution
- Fibre Channel clock and data distribution
- Backplane distribution

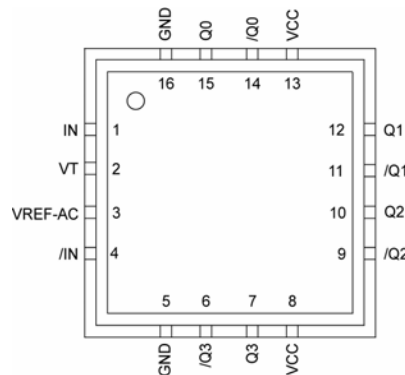
Ordering Information⁽¹⁾

| Part Number | Package Type | Operating Range | Package Marking | Lead Finish |
|-----------------------------|--------------|-----------------|--------------------------------------|----------------|
| SY89854UMG | MLF-16 | Industrial | 854U with Pb-free bar-line indicator | Pb-Free NiPdAu |
| SY89854UMGTR ⁽²⁾ | MLF-16 | Industrial | 854U with Pb-free bar-line indicator | Pb-Free NiPdAu |

Notes:

- Contact factory for die availability. Dice are guaranteed at T_A = 25°C, DC Electricals Only.
- Tape and Reel.

Pin Configuration

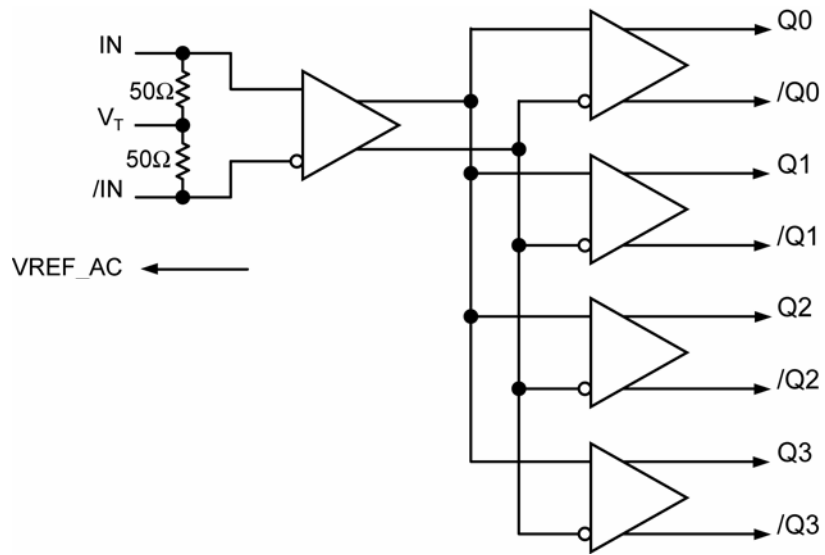


16-Pin MLF[®] (MLF-16)

Pin Description

| Pin Number | Pin Name | Pin Function |
|-----------------------------------|--|--|
| 1, 4 | IN, /IN | Differential Input: This input pair is the signal to be buffered. These inputs accept AC- or DC-coupled differential signals as small as 100mV (200mV _{pp}). Each pin of this pair internally terminates to a VT pin through 50Ω. Note that this input will default to an indeterminate state if left open. Please refer to the “Input Interface Applications” section for more details. |
| 2 | VT | Input Termination Center-Tap: Each side of the differential input pair terminates to this pin. The VT pin provides a center-tap to a termination network for maximum interface flexibility. See “Input Interface Applications” section for more details. |
| 8,13 | VCC | Positive Power Supply. Bypass with 0.1μF 0.01μF low ESR capacitors as close to the VCC pin as possible. |
| 15, 14 12, 11 10, 9 7, 6 | Q0, /Q0 Q1, /Q1 Q2, /Q2 Q3, /Q3 | Differential 100K LVPECL Output: These LVPECL outputs are the precision, low skew copies of the input signal. Terminate with 50Ω to V _{CC} -2V. Unused output pairs may be left floating with no impact on jitter. See “Output Interface Applications” section. |
| 5, 16 | GND, Exposed Pad | Ground. Ground pin and exposed pad must be connected to the same ground plane. |
| 3 | VREF-AC | Reference Voltage: This output biases to V _{CC} -1.2V. It is used when AC coupling the inputs (IN, /IN). Connect VREF-AC to the VT pin. Bypass VREF-AC pin with a 0.01μF low ESR capacitor to V _{CC} . Maximum sink/source capability is 1.5mA. See “Input Interface Applications” section for more details. |

Functional Block Diagram



Absolute Maximum Ratings⁽¹⁾

| | | |
|--|-------|-------------------|
| Supply Voltage (V_{CC}) | | -0.5V to +4.0V |
| Input Voltage (V_{IN}) | | -0.5V to V_{CC} |
| LVPECL Output Current (I_{OUT}) | | |
| Continuous | | 50mA |
| Surge | | 100mA |
| Termination Current ⁽³⁾ | | |
| Source or sink current on V_T | | ± 50 mA |
| Input Current | | |
| Source or sink current on I_N , $/I_N$ | | ± 50 mA |
| VREF-AC Current ⁽³⁾ | | |
| Source or sink current | | ± 2 mA |
| Lead Temperature (soldering, 20sec.) | | +260°C |
| Storage Temperature (T_s) | | -65°C to 150°C |

Operating Ratings⁽²⁾

| | | |
|---|-------|--------------------|
| Supply Voltage (V_{CC}) | | +2.375V to +2.625V |
| | | +3.0V to +3.6V |
| Ambient Temperature (T_A) | | -40°C to +85°C |
| Package Thermal Resistance ⁽⁴⁾ | | |
| MLF [®] (θ_{JA}) | | |
| Still-Air | | 60°C/W |
| MLF [®] (ψ_{JB}) | | |
| Junction-to-Board | | 38°C/W |

DC Electrical Characteristics⁽⁵⁾

$T_A = -40^\circ\text{C}$ to $+85^\circ\text{C}$, unless otherwise stated.

| Symbol | Parameter | Condition | Min | Typ | Max | Units |
|----------------|---|------------------------|----------------|-----|----------------|----------|
| V_{CC} | Power Supply | | 2.375 | 2.5 | 2.625 | V |
| | | | 3.0 | 3.3 | 3.6 | V |
| I_{CC} | Power Supply Current | No load, max. V_{CC} | | 55 | 78 | mA |
| R_{DIFF_IN} | Differential Input Resistance (I_N , $/I_N$) | | 90 | 100 | 110 | Ω |
| R_{IN} | Input Resistance (I_N -to- V_T) | | 45 | 50 | 55 | Ω |
| V_{IH} | Input High Voltage (I_N , $/I_N$) | | $V_{CC} - 1.2$ | | V_{CC} | V |
| V_{IL} | Input Low Voltage (I_N , $/I_N$) | | 0 | | $V_{IH} - 0.1$ | V |
| V_{IN} | Input Voltage Swing (I_N , $/I_N$) | See Figure 1a. | 0.1 | | 1.7 | V |
| V_{DIFF_IN} | Differential Input Voltage Swing (I_N , $/I_N$) | See Figure 1b. | 0.2 | | | V |
| V_{T_IN} | I_N -to- V_T | | | | 1.28 | V |

Notes:

1. Permanent device damage may occur if the Absolute Maximum Ratings are exceeded. This is a stress rating only and functional operation is not implied at conditions other than those detailed in the operational sections of this data sheet. Exposure to Absolute Maximum Ratings conditions for extended periods may affect device reliability.
2. The data sheet limits are not guaranteed if the device is operated beyond the operating ratings.
3. Due to the limited drive capability use for input of the same package only.
4. Package thermal resistance assumes exposed pad is soldered (or equivalent) to the devices most negative potential on the PCB. θ_{JA} and ψ_{JB} are calculated based on a 4-layer board in still air, unless otherwise stated.
5. The circuit is designed to meet the DC specifications shown in the above table after thermal equilibrium has been established.

LVPECL Outputs DC Electrical Characteristics⁽⁷⁾

$V_{CC} = +2.5V \pm 5\%$ or $+3.3V \pm 10\%$; $T_A = -40^\circ C$ to $+85^\circ C$; $R_L = 50\Omega$ to $V_{CC} - 2V$, unless otherwise stated.

| Symbol | Parameter | Condition | Min | Typ | Max | Units |
|----------------|---|----------------|------------------|------|------------------|-------|
| V_{OH} | Output HIGH Voltage Q, /Q | | $V_{CC} - 1.145$ | | $V_{CC} - 0.895$ | V |
| V_{OL} | Output LOW Voltage Q, /Q | | $V_{CC} - 1.945$ | | $V_{CC} - 1.695$ | V |
| V_{OUT} | Output Voltage Swing Q, /Q | See Figure 1a. | 550 | 800 | | mV |
| $V_{DIFF-OUT}$ | Differential Output Voltage Swing Q,/Q | See Figure 1b. | 1100 | 1600 | | mV |

Note:

7. The circuit is designed to meet the DC specifications shown in the above table after thermal equilibrium has been established.

AC Electrical Characteristics⁽⁸⁾

$V_{CC} = +2.5V \pm 5\%$ or $+3.3V \pm 10\%$; $T_A = -40^\circ C$ to $+85^\circ C$, $R_L = 50\Omega$ to $V_{CC} - 2V$, unless otherwise stated.

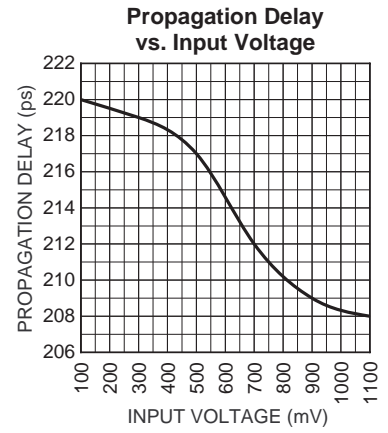
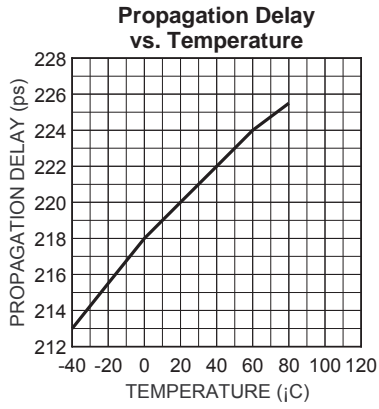
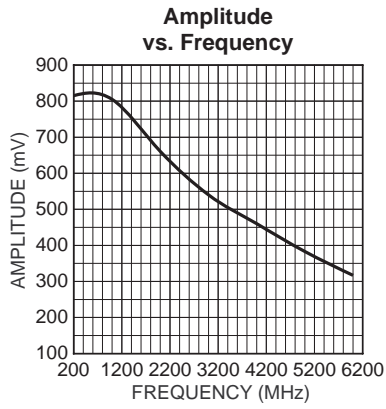
| Symbol | Parameter | Condition | Min | Typ | Max | Units |
|--------------------|--|-----------------------------|-----|-----|-----|---------------------|
| f_{MAX} | Maximum Operating Frequency | Clock, $V_{OUT} \geq 400mV$ | 2.0 | 3.5 | | GHz |
| | | NRZ Data | | 2.5 | | Gbps |
| t_{pd} | Propagation Delay (IN-to-Q) | $V_{IN} \geq 100mV_{pk}$ | 140 | 220 | 340 | ps |
| t_{pd} Tempco | Differential Propagation Delay Temperature Coefficient | | | 100 | | fs/ $^\circ C$ |
| t_{SKEW} | Output-to-Output Skew | Note 9 | | 4 | 20 | ps |
| | Part-to-Part Skew | Note 10 | | | 150 | ps |
| t_{Jitter} | Random Jitter (RJ) | Note 11 | | | 1 | ps _(rms) |
| | Deterministic Jitter (DJ) | Note 12 | | | 10 | ps _(pp) |
| | Cycle-to-Cycle Jitter | Note 13 | | | 1 | ps _(rms) |
| | Total Jitter | Note 14 | | | 10 | ps _(pp) |
| t_r, t_f | Output Rise/Fall Time (20% to 80%) | At full output swing. | 50 | 100 | 180 | ps |

Notes:

8. High-frequency AC-parameters are guaranteed by design and characterization.
9. Output-to-output skew is measured between outputs under identical conditions.
10. Part-to-part skew is defined for two parts with identical power supply voltages at the same temperature and with no skew of the edges at the respective inputs. Part-to-part skew includes variation in t_{pd} .
11. Random jitter is measured with a K28.7 character pattern, measured at 2.5Gbps.
12. DJ is measured at 2.5Gbps, with both K28.5 and $2^{23} - 1$ PRBS pattern.
13. Cycle-to-cycle jitter definition: The variation of periods between adjacent cycles, $T_n - T_{n-1}$ where T is the time between rising edges of the output signal.
14. Total jitter definition: with an ideal clock input of frequency $< f_{MAX}$, no more than one output edge in 10^{12} output edges will deviate by more than the specified peak-to-peak jitter value.

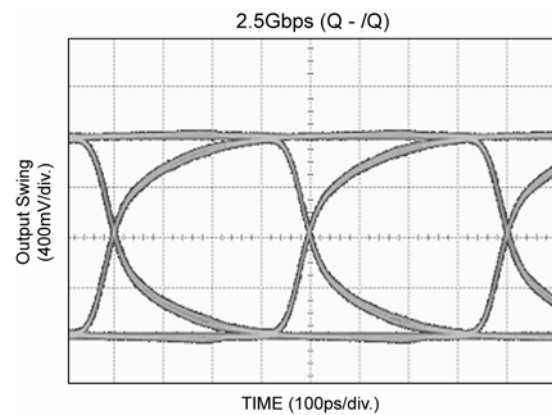
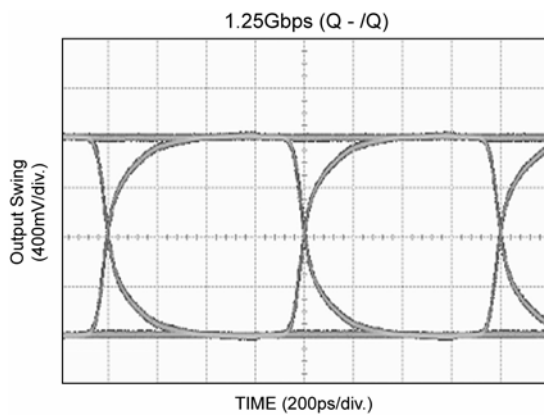
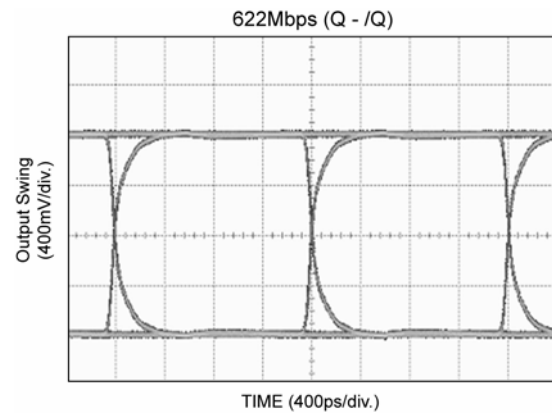
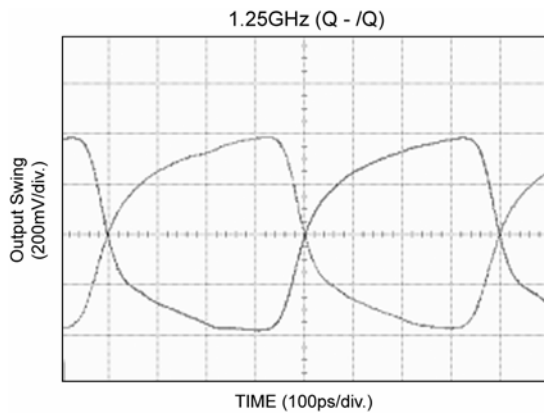
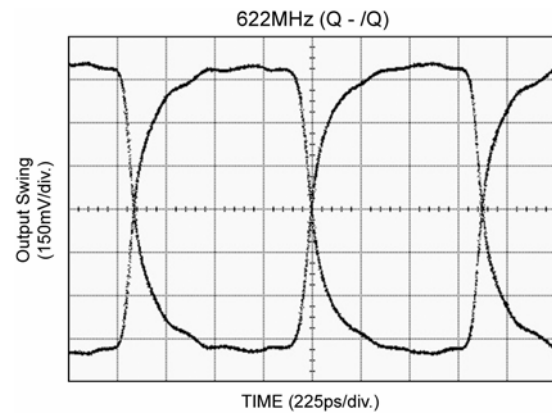
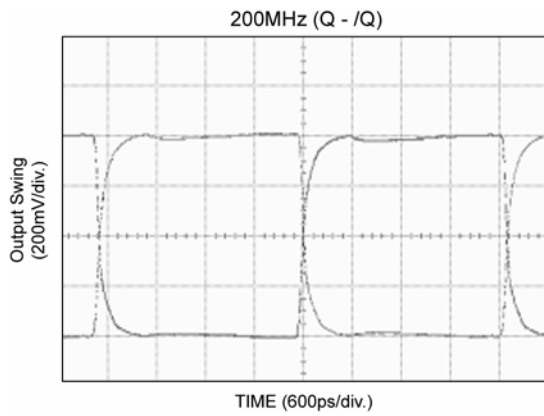
Typical Operating Characteristics

$V_{CC} = 2.5V$, $V_{IN} = 100mV_{pk}$, $T_A = 25^{\circ}C$, unless otherwise stated.



Functional Characteristics

$V_{CC} = 2.5V$, $V_{IN} = 100mV$, $T_A = 25^\circ C$, unless otherwise stated.



Single-Ended and Differential Swings

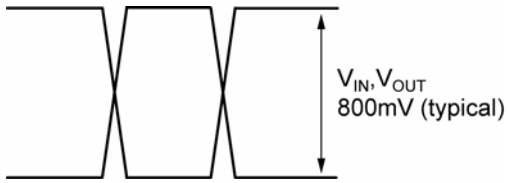


Figure 1a. Singled-Ended Voltage Swing

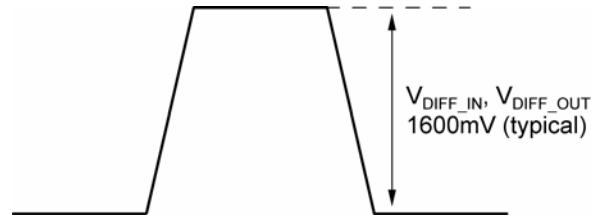
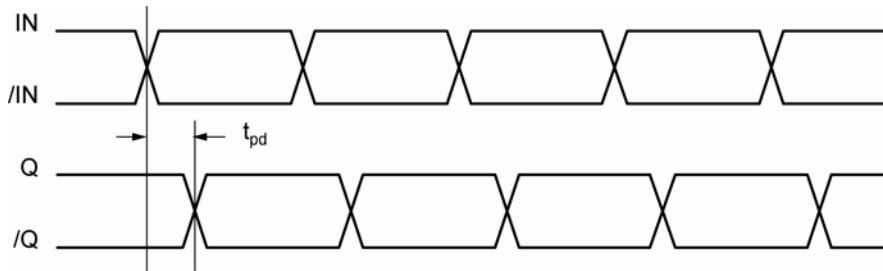


Figure 1b. Differential Voltage Swing

Timing Diagrams



Input and Output Stages

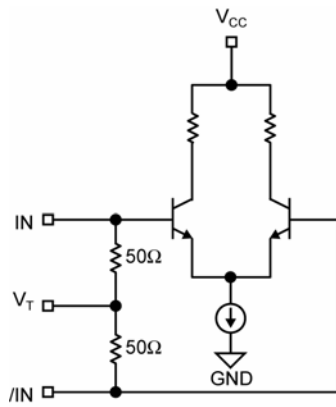


Figure 2a. Simplified Differential Input Stage

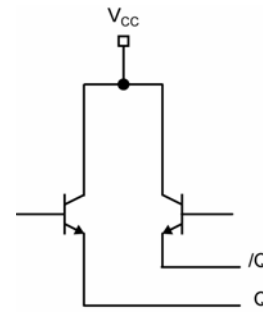
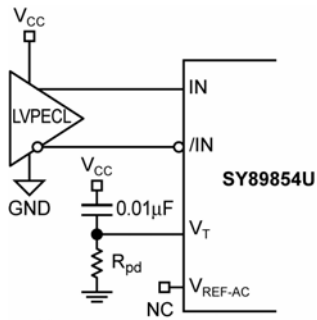


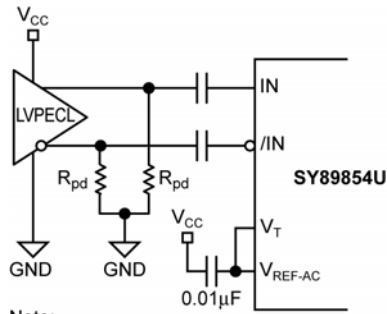
Figure 2b. Simplified LVPECL Output Stage

Input Interface Applications



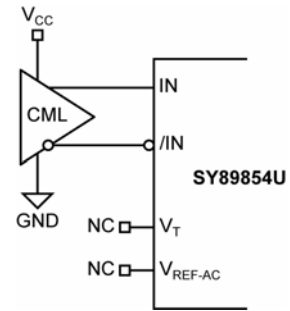
Note:
For 3.3V, $R_{pd} = 50\Omega$.
For 2.5V, $R_{pd} = 19\Omega$.

**3a. LVPECL Interface
(DC-Coupled)**



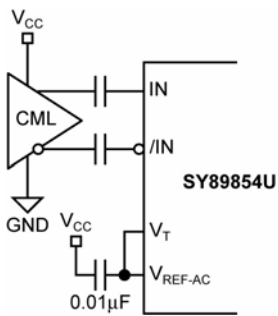
Note:
For 3.3V, $R_{pd} = 100\Omega$.
For 2.5V, $R_{pd} = 50\Omega$.

**3b. LVPECL Interface
(AC-Coupled)**

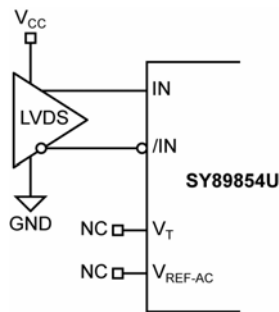


Option: may connect V_T to V_{CC}

**3c. CML Interface
(DC-Coupled)**

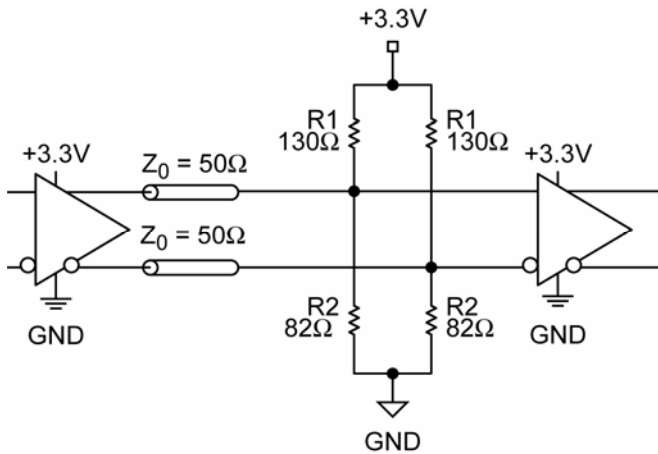


**3d. CML Interface
(AC-Coupled)**



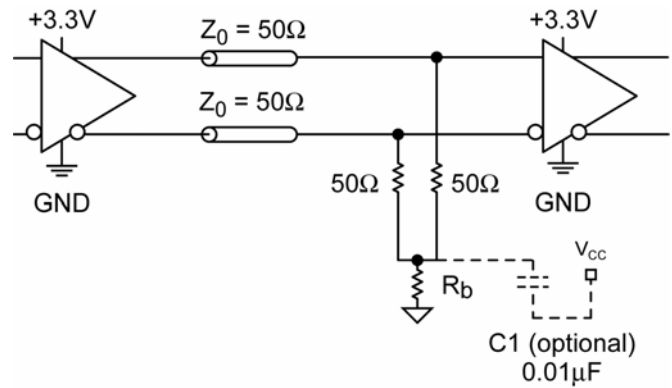
3e. LVDS Interface

Output Interface Applications



Note:
For +2.5V systems, R1 = 250Ω, R2 = 82.5Ω

Figure 4a. Parallel Thevenin-Equivalent Termination



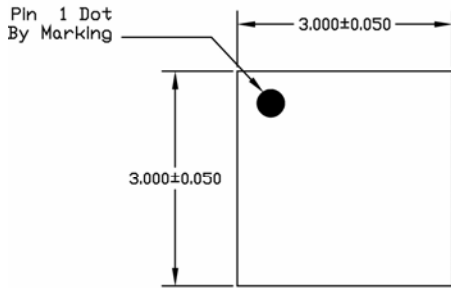
Note:
For +2.5V systems, Rb = 19Ω
For +3.3V systems, Rb = 50Ω

Figure 4b. Parallel Termination (3-Resistor)

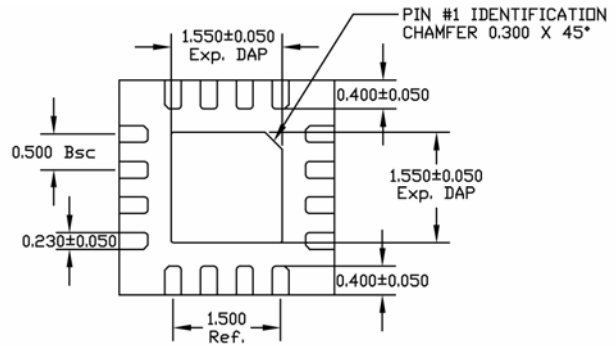
Related Product and Support Documentation

| Part Number | Function | Data Sheet Link |
|---------------|---|--|
| SY58021U | 4GHz, 1:4 LVPECL Fanout Buffer/Translator with Internal Termination | www.micrel.com/product-info/products/sy58021u.shtml |
| | MLF® Application Note | www.amkor.com/products/notes_papers/MLF_AppNote.pdf |
| HBW Solutions | New Products and Applications | www.micrel.com/product-info/products/solutions.shtml |

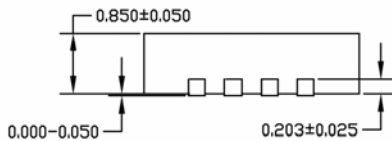
16-Pin *MicroLeadFrame*[®] (MLF-16)



TOP VIEW



BOTTOM VIEW



SIDE VIEW

- NOTE:
1. ALL DIMENSIONS ARE IN MILLIMETERS.
 2. MAX. PACKAGE WARPAGE IS 0.05 mm.
 3. MAXIMUM ALLOWABLE BURRS IS 0.076 mm IN ALL DIRECTIONS.
 4. PIN #1 ID ON TOP WILL BE LASER/INK MARKED.

Package Notes:

- (1) Package meets Level 2 Moisture Sensitivity Classification.
- (2) All parts are dry-packaged before shipment.
- (3) Exposed pad must be soldered to a ground for proper thermal management.

MICREL, INC. 2180 FORTUNE DRIVE SAN JOSE, CA 95131 USA
 TEL +1 (408) 944-0800 FAX +1 (408) 474-1000 WEB <http://www.micrel.com>

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Офис по работе с юридическими лицами:

105318, г.Москва, ул.Щербаковская д.3, офис 1107, 1118, ДЦ «Щербаковский»

Телефон: +7 495 668-12-70 (многоканальный)

Факс: +7 495 668-12-70 (доб.304)

E-mail: info@moschip.ru

Skype отдела продаж:

moschip.ru

moschip.ru_4

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